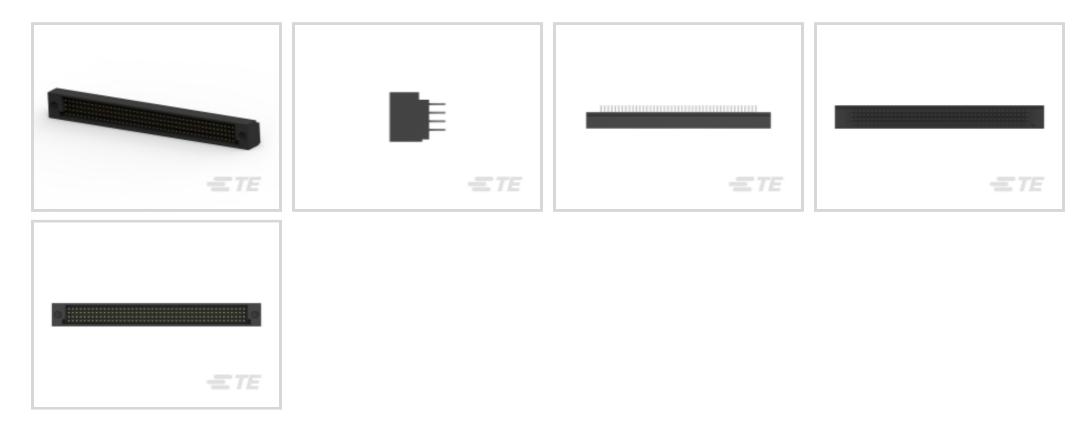
532436-6 - ACTIVE

## AMP-HDI

TE Internal #: 532436-6 PCB Mount Header, Vertical, Board-to-Board, 180 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole -Solder, Signal, Black

### View on TE.com >

#### Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 180

Number of Rows: 4

## Features

**Connectivity** 

## Product Type Features

PCB Connector Type	PCB Mount Header			
Connector System	Board-to-Board			
Header Type	Fully Shrouded			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Connector Product Type	Connector Assembly			
Configuration Features				
Stackable	No			
PCB Mount Orientation	Vertical			
PCB Mount Orientation Number of Positions	Vertical 180			
Number of Positions	180			
Number of Positions Number of Rows	180			

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Primary Product Color	Black	
Contact Features		
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]	
Mating Square Post Dimension	.64 mm[.025 in]	
Contact Shape & Form	Four Beam	
Contact Layout	Matrix	
	.21 in	
Contact Base Material	Phosphor Bronze	
PCB Contact Termination Area Plating Material	Tin	
Contact Mating Area Plating Material	Gold (Au)	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Termination Post & Tail Length	4.83 mm[.19 in]	
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Method to PCB	Through Hole - Solder	

## Mechanical Attachment

Mating Alignment Type	Keyed			
PCB Mount Retention Type	Retention Solder Tails			
PCB Mount Retention	Without			
PCB Mount Alignment	Without			
Connector Mounting Type	Board Mount			
Mating Alignment	Without			
Housing Features				
Housing Material	Thermoplastic			
Centerline (Pitch)	2.54 mm[.1 in]			
Dimensions				
Dimensions				
PCB Thickness (Recommended)	1.57 mm[.76 in]			
	1.57 mm[.76 in] 11.73 mm[.462 in]			
PCB Thickness (Recommended)				
PCB Thickness (Recommended) Connector Height				

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## **Operation/Application**

Solder Process Feature	Board Standoff			
Circuit Application	Signal			
Industry Standards				
UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Quantity	4			
Packaging Method	Tube			
Product Compliance For compliance documentation, visit the product page on TE.com>				
EU RoHS Directive 2011/65/EU	Not Compliant			
EU ELV Directive 2000/53/EC	Compliant with Exemptions			
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold			
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025			

#### Halogen Content

Solder Process Capability

### Pb (13% in 4690948374)

SVHC > Threshold:

#### Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Not lead free process capable

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts

**&** For support call+1 800 522 6752

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# Customers Also Bought

-ETE



HDI RECP ASSY 4 ROW 200 POS	HDI PIN ASSY 4 ROW 120 POS	MOD IV RECP LP	HDI PIN ASSY 4 ROW 200 POS
		and the second sec	

TE Part #530341-1

BOX EST KEY PASSIVATED

=TE

BOX II 4 ROW 100 POS RECP ASSY

TE Part #533285-1



TE Part #211600-2

DUST COVER, SZ 2, NIC 600

## Documents

TE Part #532447-8

HDI PIN ASSY 3 ROW 165 POS

PCB Mount Header, Vertical, Board-to-Board, 180 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Solder, Signal, Black



Product Drawings HDI PIN ASSY 4 ROW 180 POS

English

**CAD** Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_532436-6\_T.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_532436-6\_T.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_532436-6\_T.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Datasheets & Catalog Pages 1-1773957-5\_AMP\_HDI\_BTB\_CONNECTORS\_EN

English

Product Specifications Application Specification

English

Instruction Sheets Instruction Sheet (U.S.)

English

Agency Approvals Agency Approval Document

English